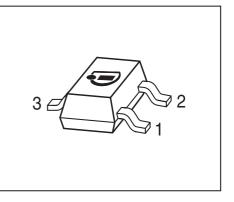


BFR193

NPN Bipolar RF Transistor

- For low noise, high-gain amplifiers up to 2 GHz
- For linear broadband amplifiers
- $f_{\rm T}$ = 8 GHz, $NF_{\rm min}$ = 1 dB at 900 MHz
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking		Pir	Config	Package		
BFR193	RCs	1 = B	3 2 = E		3 = C	SOT23	
Maximum Ratings at $T_A = 25$	°C, unless	otherwis	se sp	ecified			
Parameter			Syı	nbol	Value		Unit
Collector-emitter voltage			V _{CE}	EO	12		V
Collector-emitter voltage				ES	20		
Collector-base voltage			VCE	30	20		
Emitter-base voltage				30	2	2	
Collector current			I _C 80		80	mA	
Base current			I _B		10		
Total power dissipation ¹⁾			Ptot	t l	580		mW
<i>T</i> _S ≤ 69°C							
unction temperature				150	150		
Storage temperature			T _{St}	a	-55 15	50	7

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	140	K/W

 $^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.]
DC Characteristics	•		•	•	•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
<i>V</i> _{EB} = 1 V, <i>I</i> _C = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25°C, unless otherwise specified



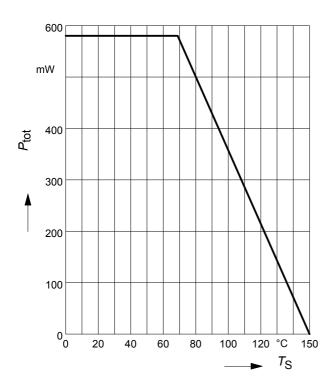
Parameter	Symbol	Values			Unit	
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f _T	6	8	-	GHz	
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.66	1	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.28	-		
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	2.25	-		
V _{EB} = 0.5 V, <i>f</i> = 1 MHz, V _{CB} = 0 ,						
collector grounded						
Minimum noise figure	NF _{min}				dB	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	1	-		
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 1.8 GHz		-	1.6	-		
Power gain, maximum available ¹⁾	G _{ma}					
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 900 {\rm MHz}$		-	15	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 1.8 {\rm GHz}$		-	10	-		
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 900 MHz		-	13	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 1.8 GHz		-	7.5	-		

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21} / S_{12}| (k - (k^{2} - 1)^{1/2})$

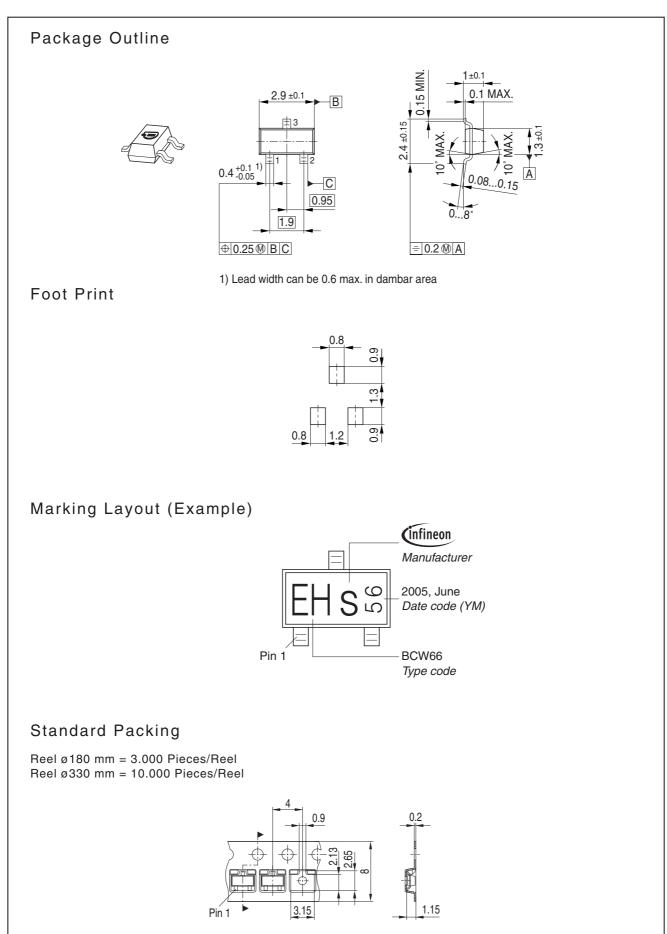


Total power dissipation $P_{tot} = f(T_S)$





BFR193







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